

# From Sensor to System; Sensor Architecting

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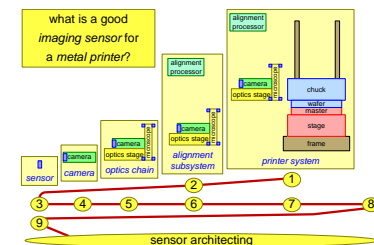
## Abstract

Researchers of sensors, typically focus on a set of critical characteristics of the sensors. However, do we know what is critical from a broader perspective, such as a device builder, a subsystem builder, the system, or the user of the system?

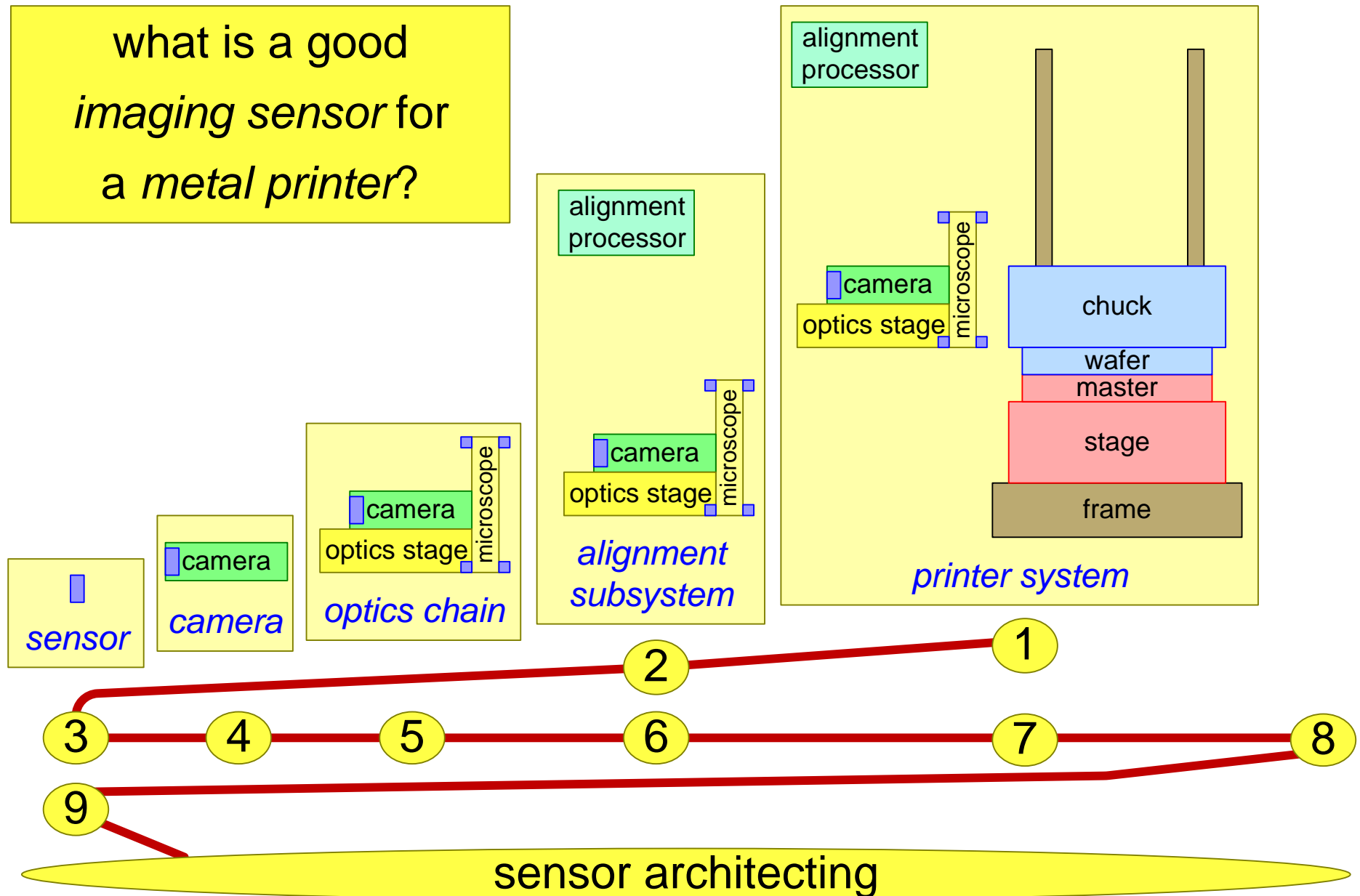
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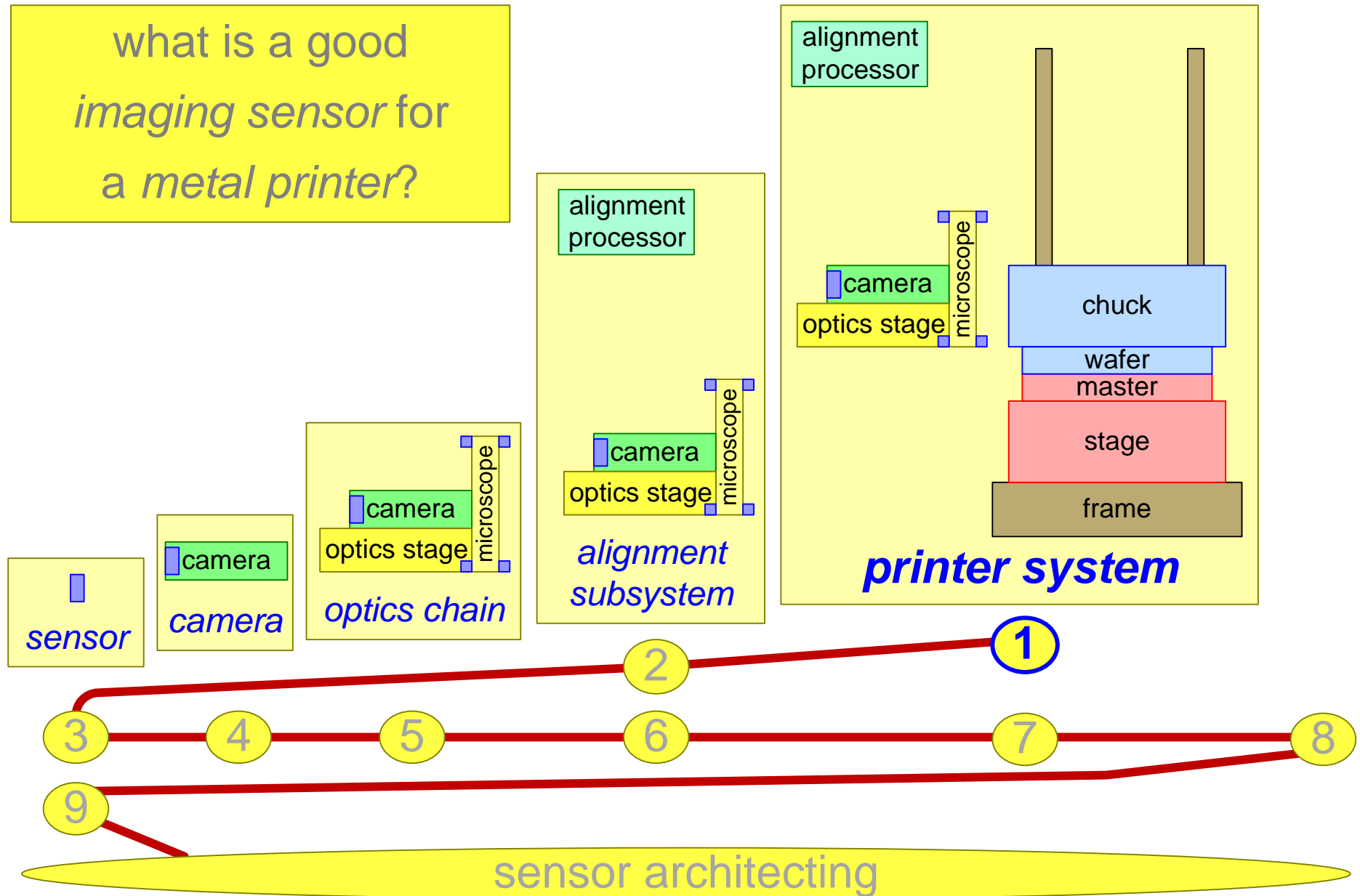
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draft  
version: 0.1



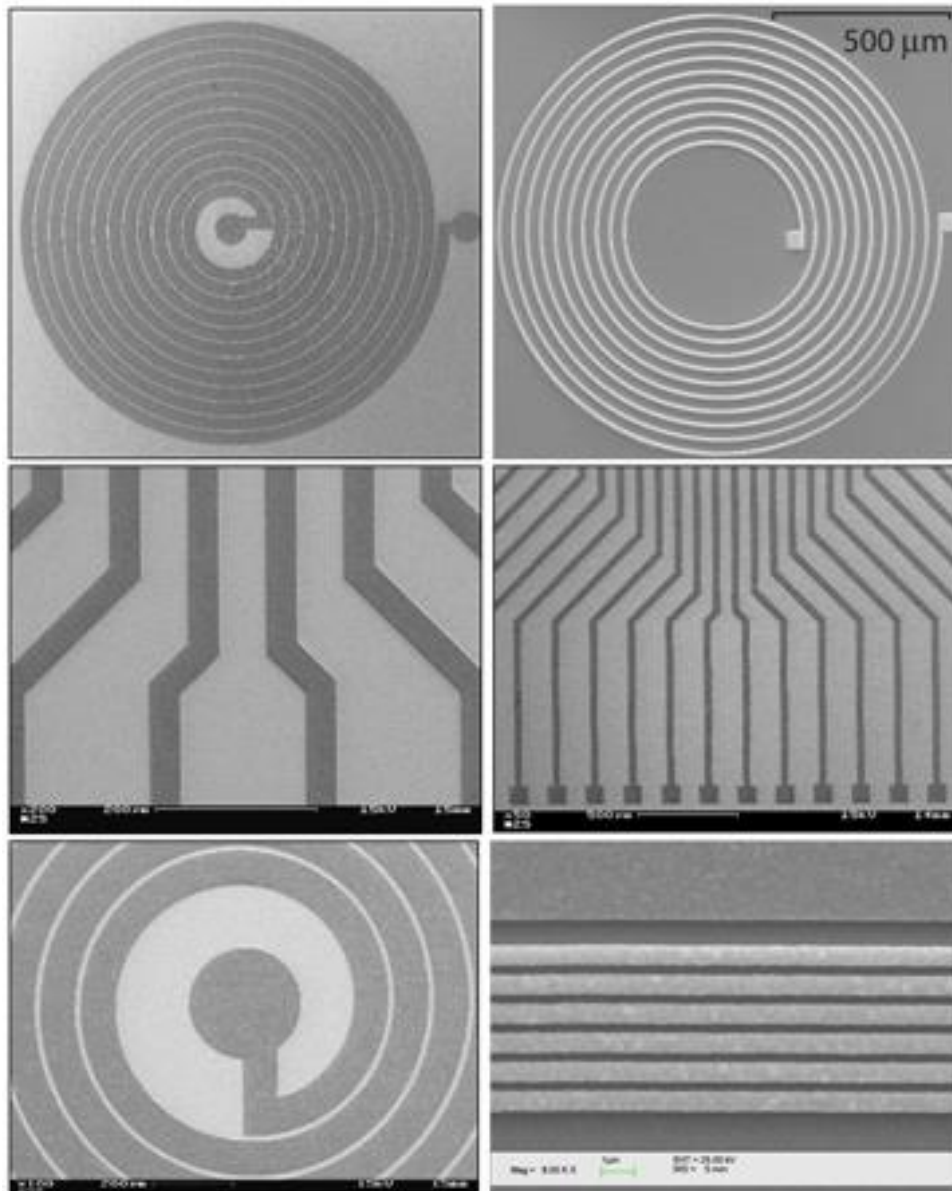
# Figure of Contents™



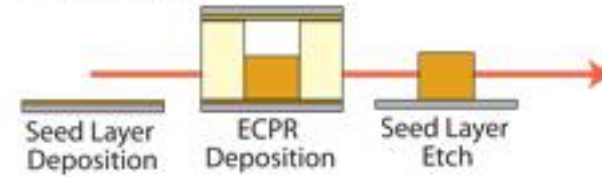
# The System: a Metal Printer



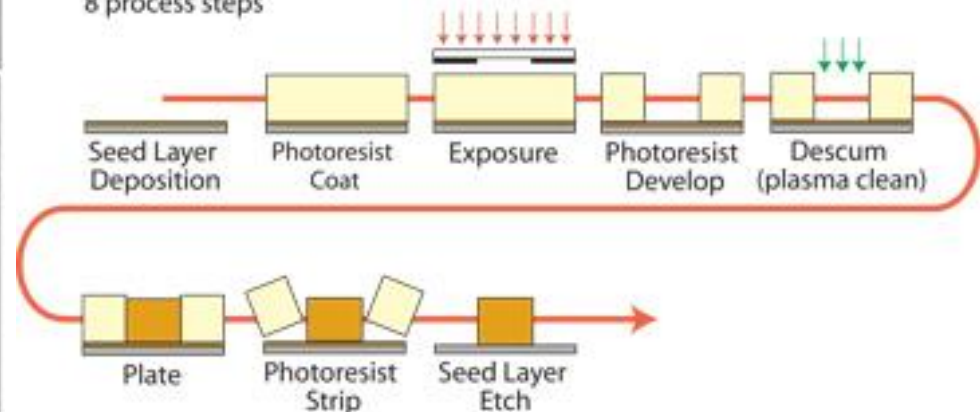
# Application of the System



## ECPR - ElectroChemical Pattern Replication 3 process steps



## Conventional lithography based metallization 8 process steps



A metal printer  
replaces 6 process step by 1 process step.  
It prints an entire wafer at once.

# Where will your Sensor be used?

*Indicate the equivalent levels for your sensor or actuator*

sensor

imaging sensor

device

camera

component

optics chain

subsystem

alignment

system

printer

application

metal printing

# Worksheet: Note 3..5 KPPs for your Sensor

sensor

imaging sensor

device

camera

component

optics chain

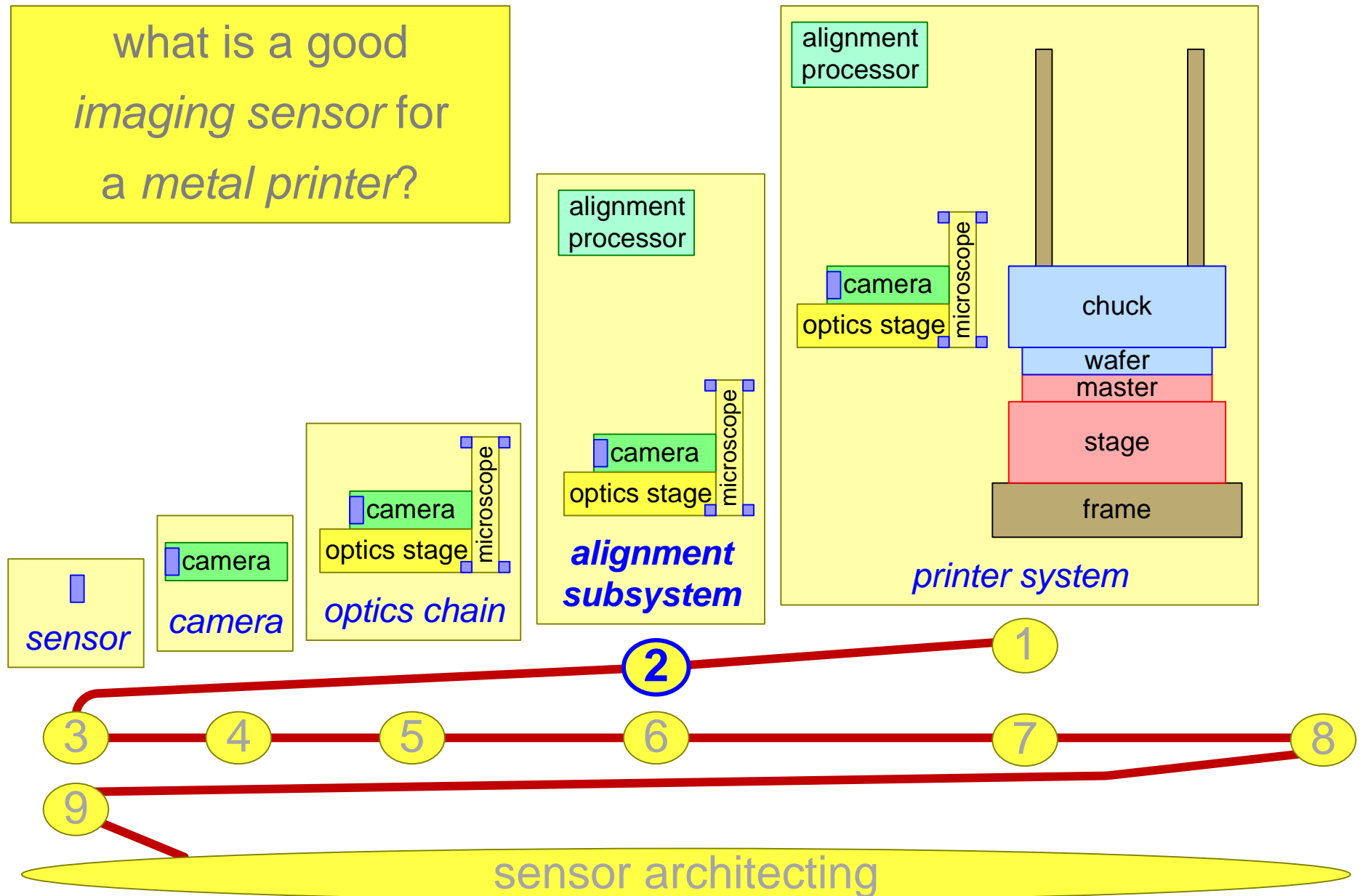
subsystem

alignment

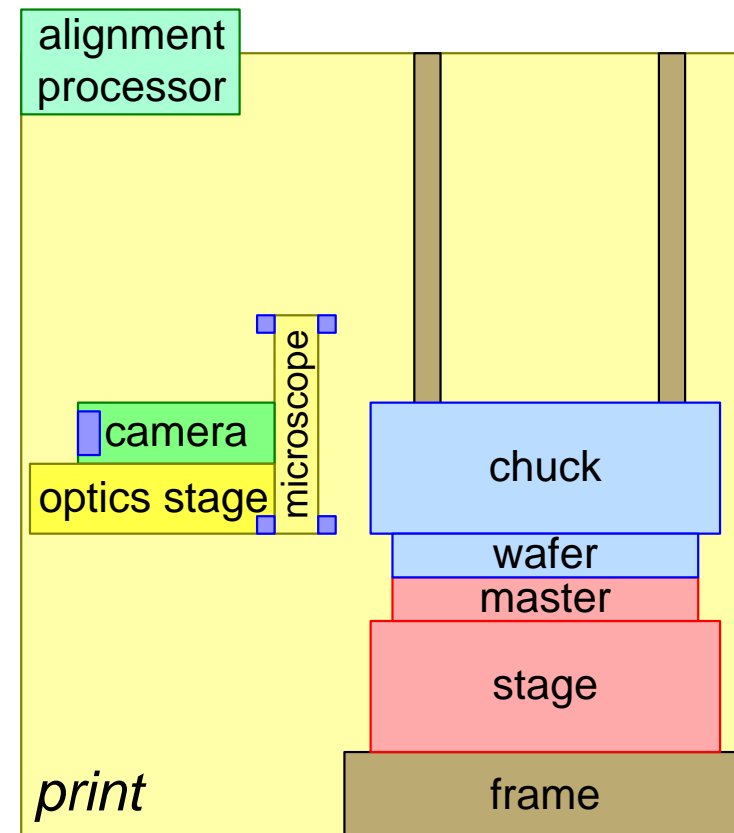
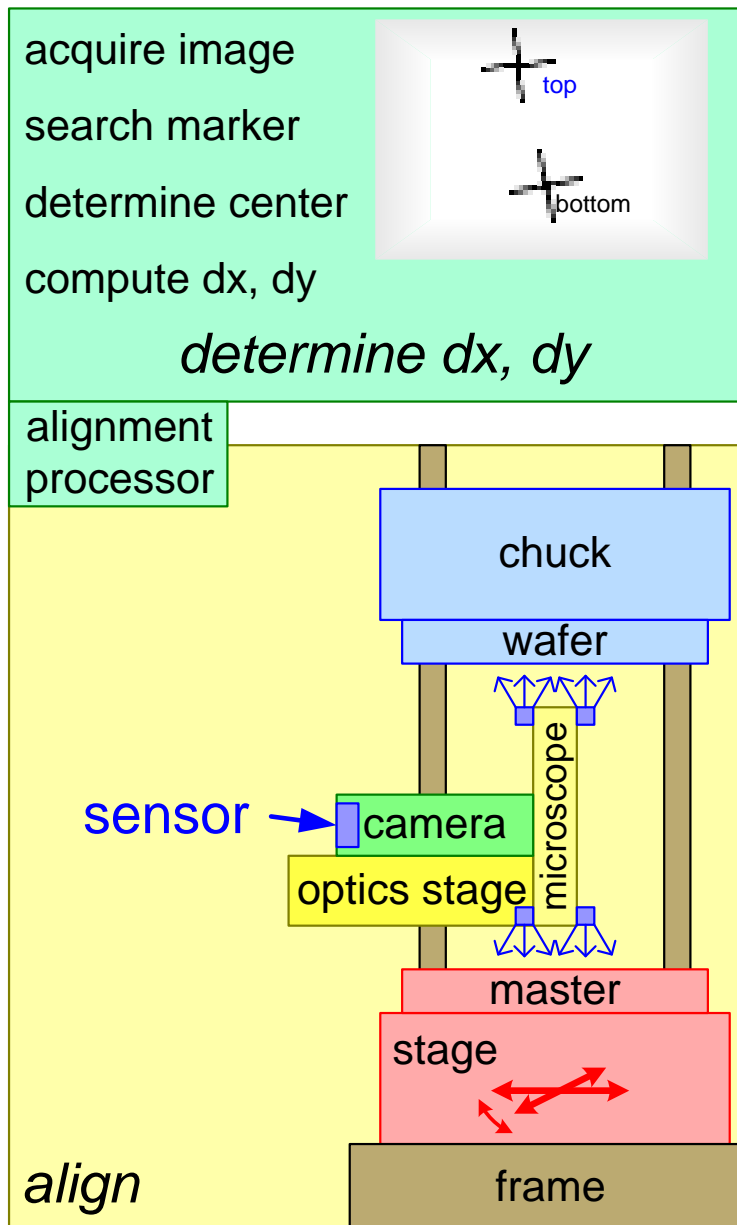
system

printer

# The Subsystem: Alignment

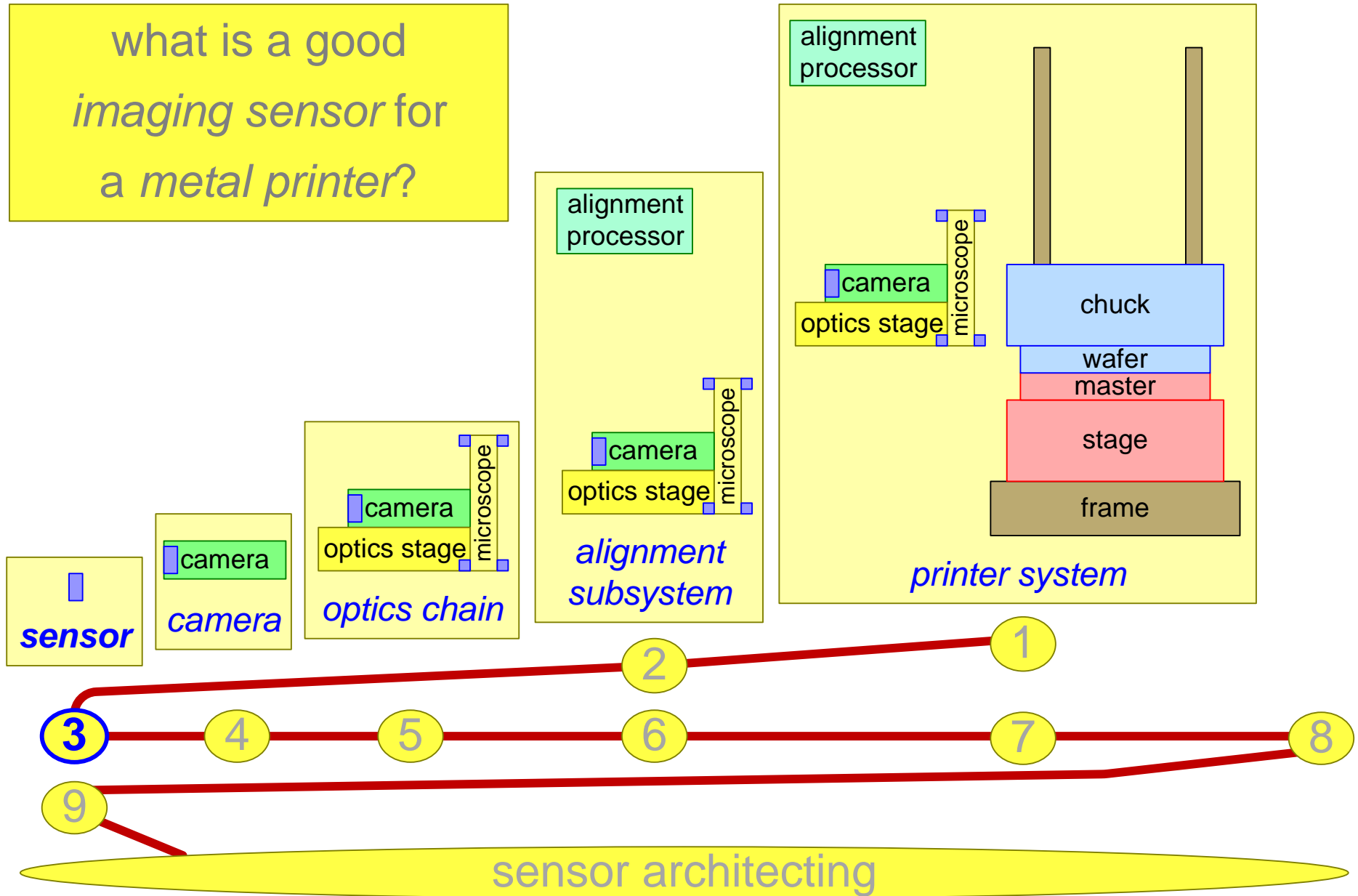


# Basics of Alignment Function

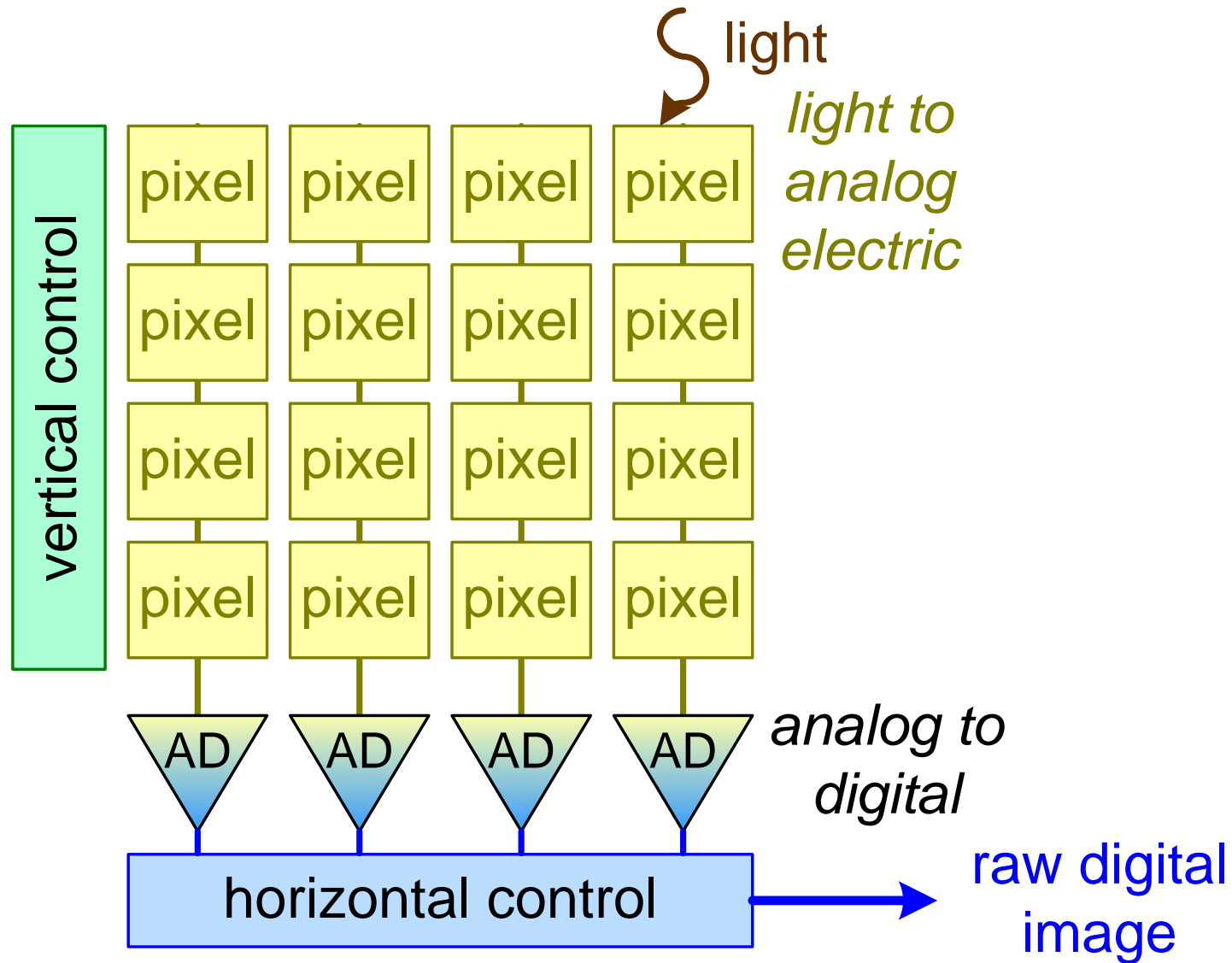




# The Sensor



# Sensor Block Diagram



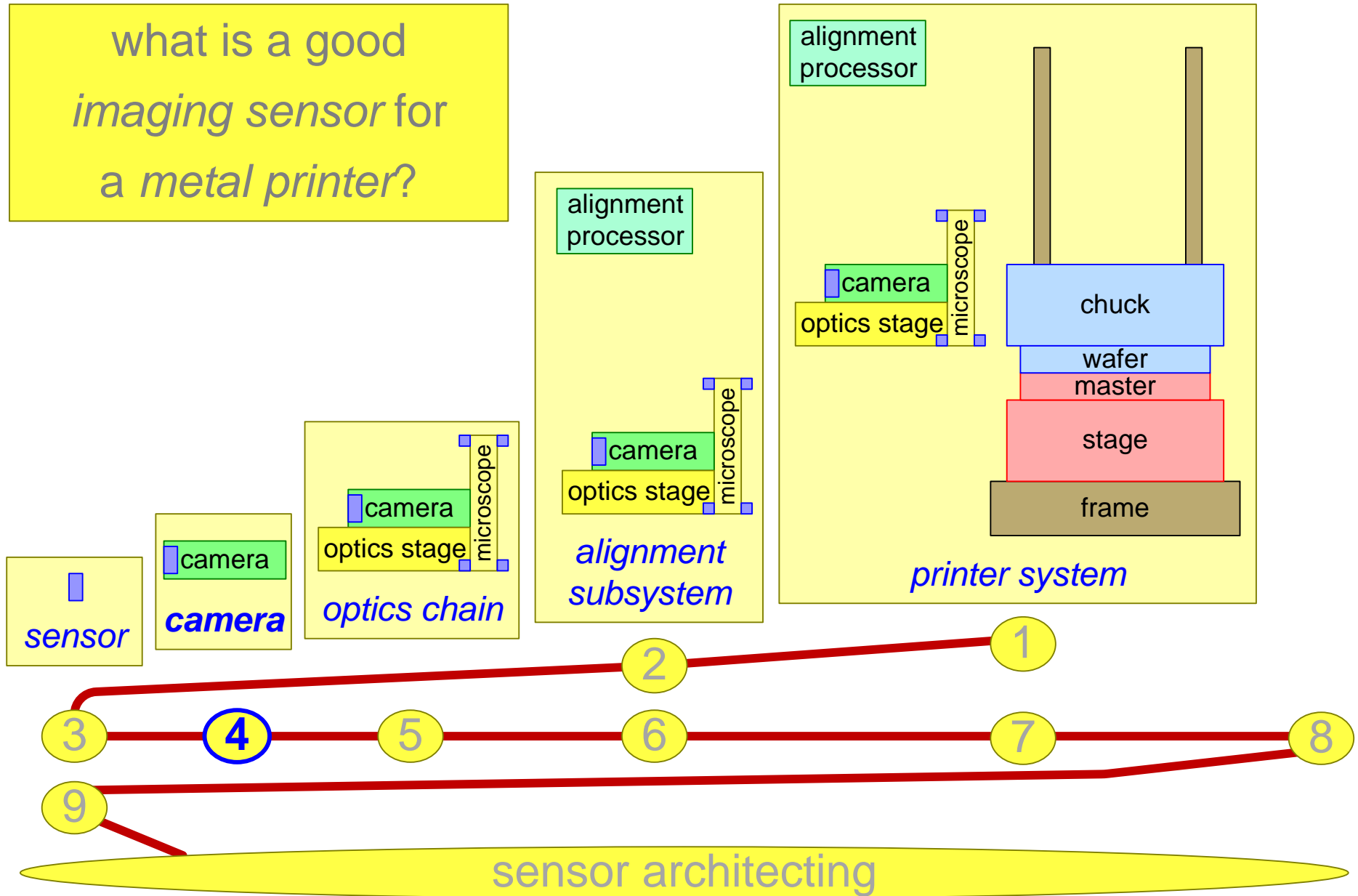
What are the 3 to 5  
*Key Performance Parameters*  
of the sensor?

What are the 3 to 5  
*Key Performance Parameters*  
of your sensor?

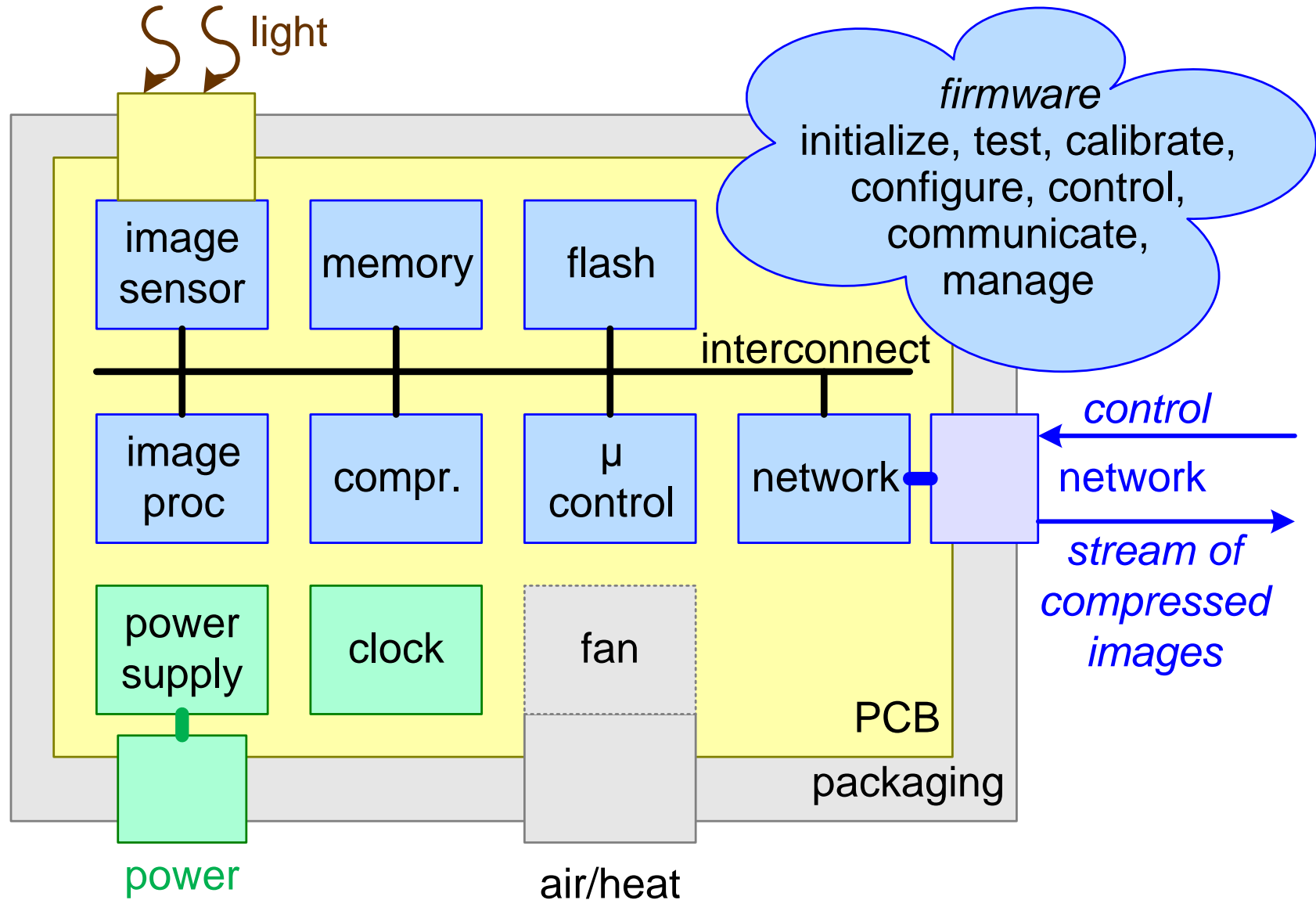
## Possible *Key Performance Parameters* of the sensor

- spatial resolution
- contrast resolution
- frame rate
- image acquisition time
- image uniformity
- sensor size
- energy consumption
- cost price
- color range
- sensitivity

# The Camera



# Camera Block Diagram



What are the 3 to 5  
*Key Performance Parameters*  
of the camera?

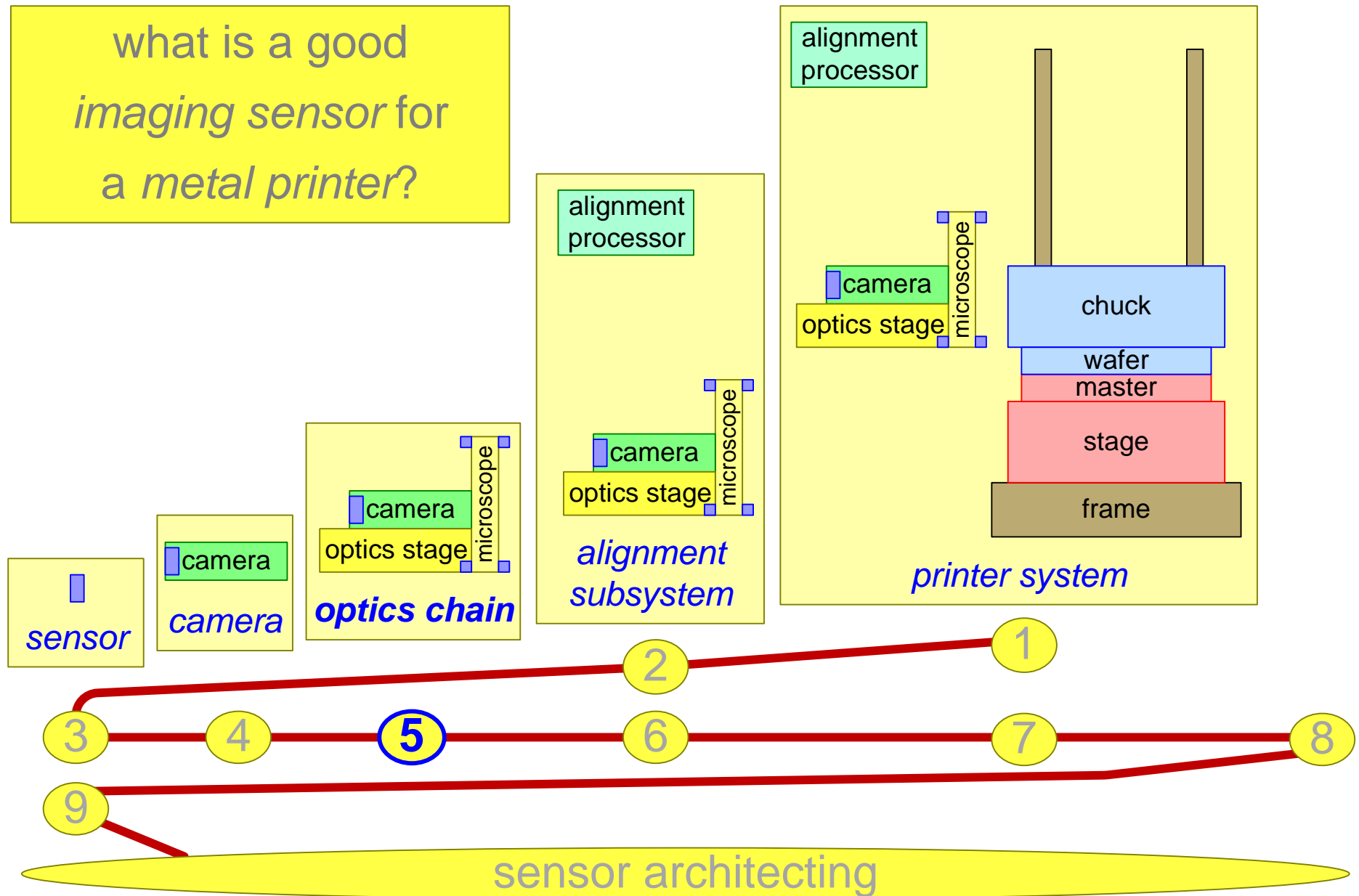
What are the 3 to 5  
*Key Performance Parameters*  
of the device incorporating your  
sensor?

## Possible *Key Performance Parameters* of the camera

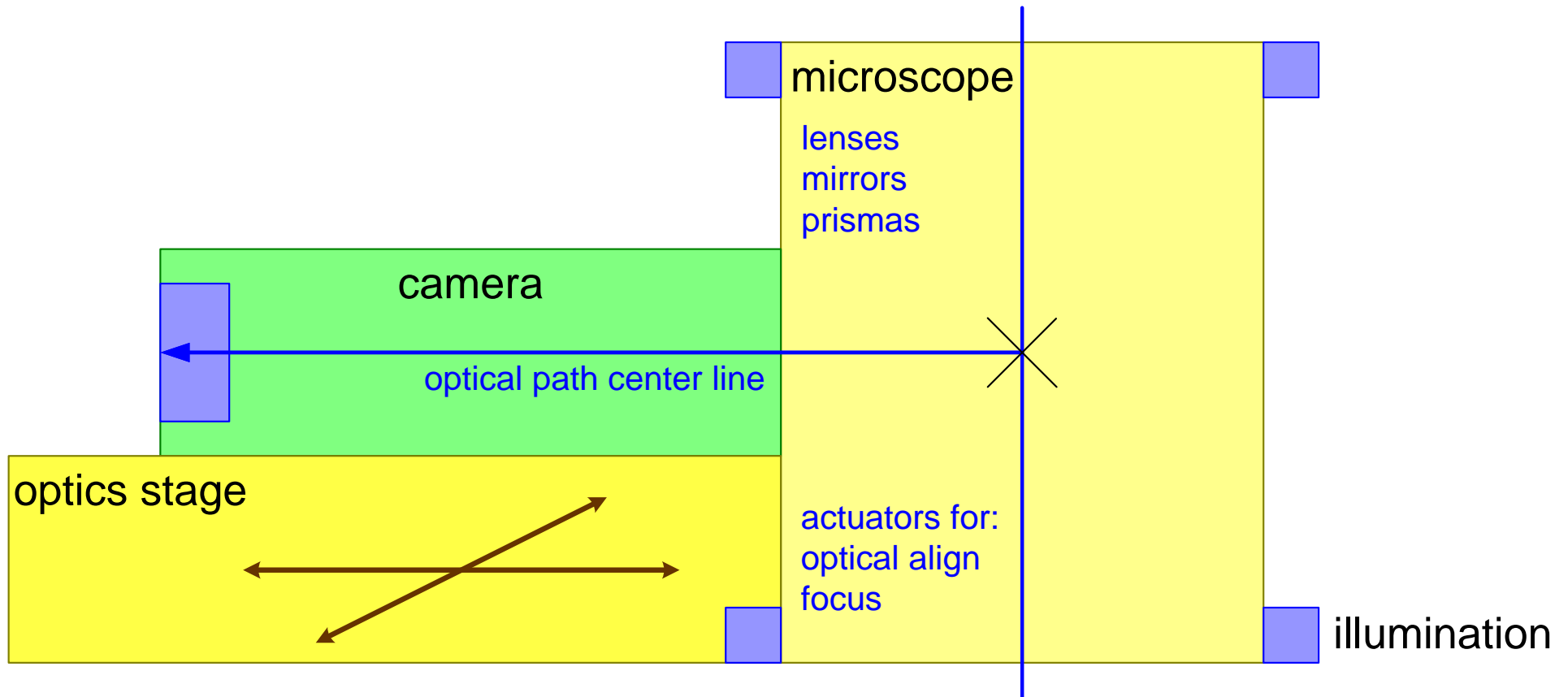
- image quality (resolution, uniformity, color range)
- acquisition performance (frame rate, acquisition time)
- camera size, weight
- camera energy consumption, thermal stability
- camera cost price
- storage capacity
- compression rate and quality
- communication performance



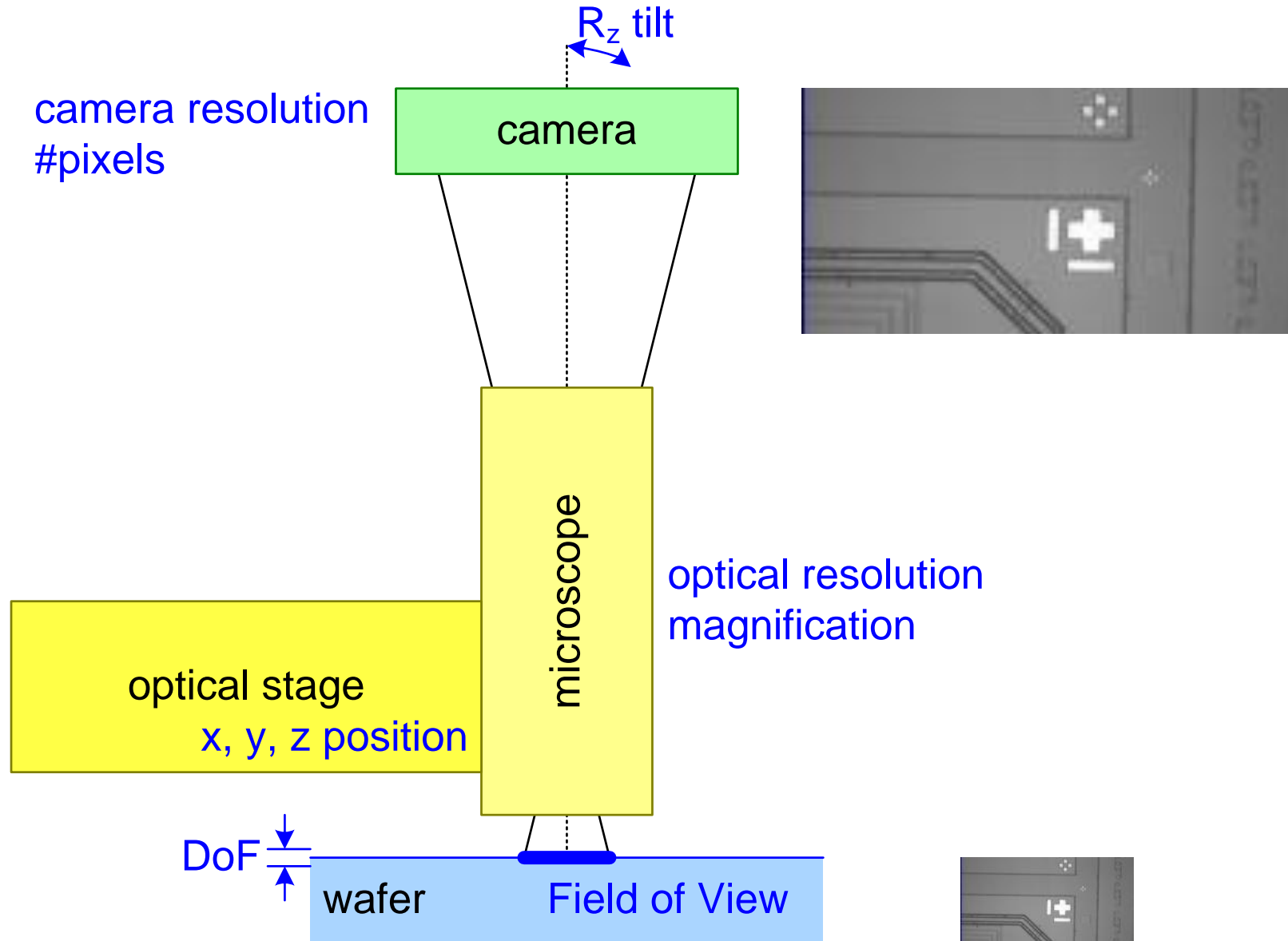
# The Optics Chain



# Optics Chain Block Diagram



# Optics Chain



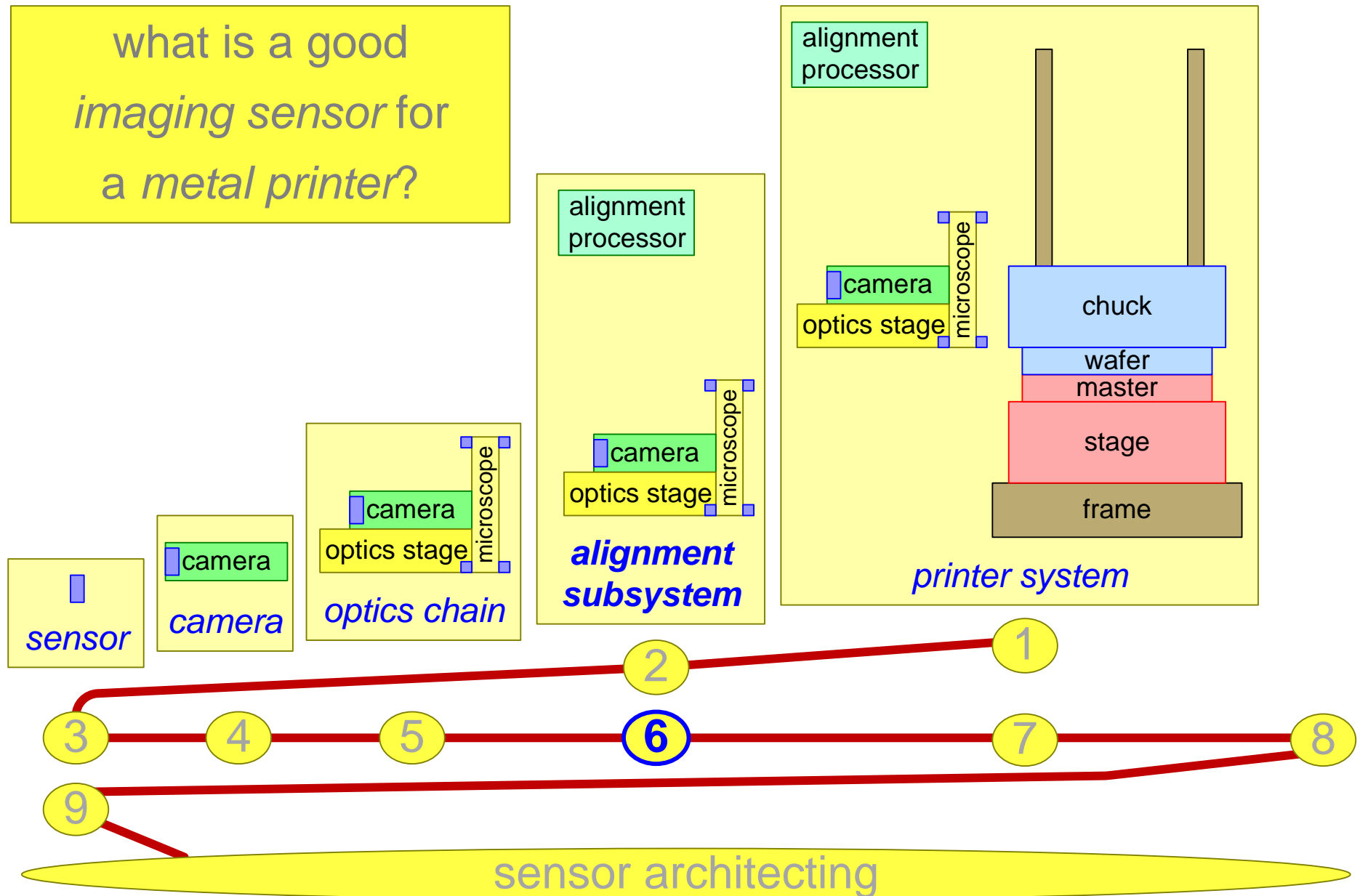
What are the 3 to 5  
*Key Performance Parameters*  
of the optics chain?

What are the 3 to 5  
*Key Performance Parameters*  
of the component incorporating your  
sensor?

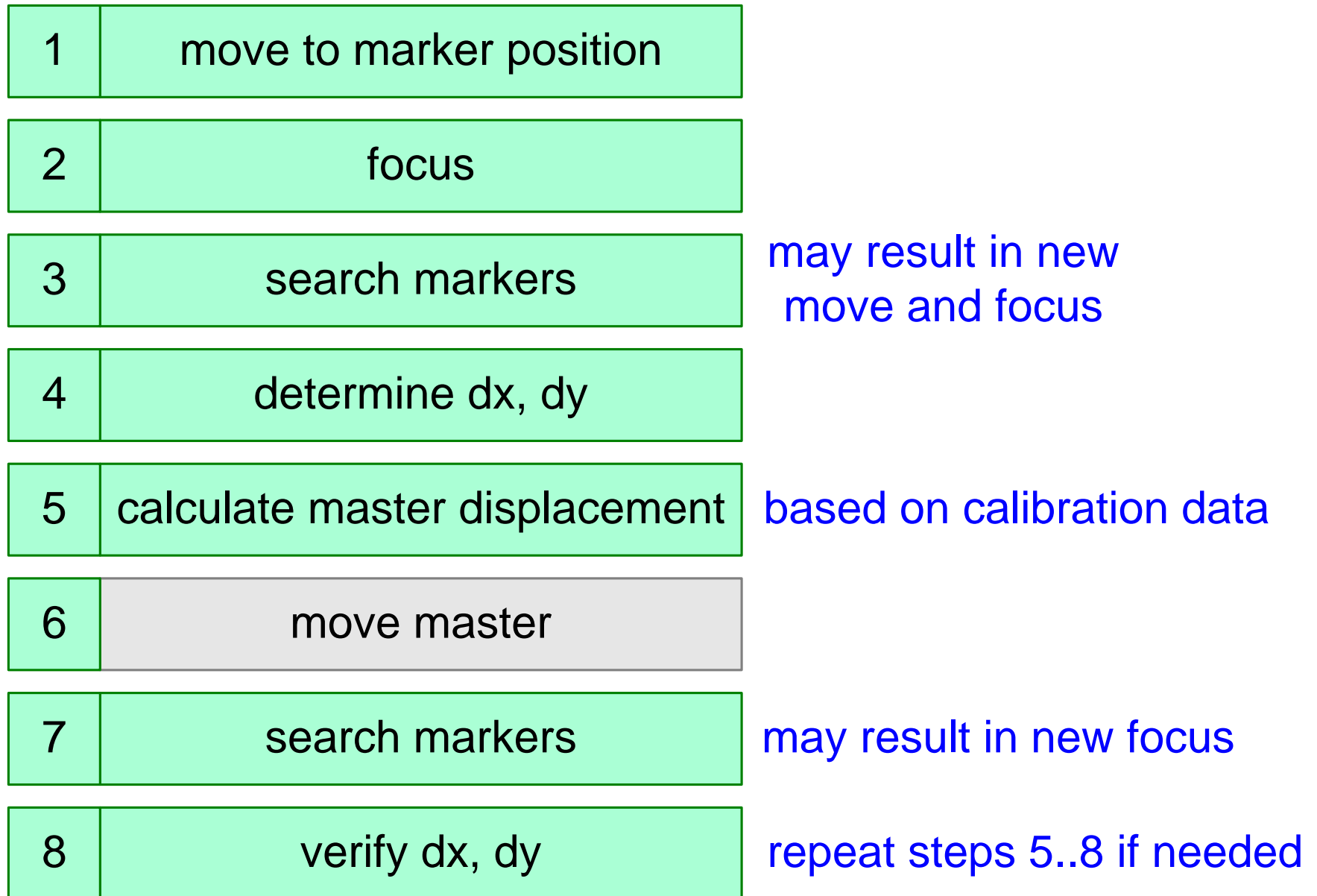
## Possible *Key Performance Parameters* of the optics chain

- position and angle stability
- wafer-to-sensor image quality (resolution, uniformity, color range)
- vertical size
- acquisition performance (frame rate, acquisition time)
- stage performance (speed, stability, reproducibility)
- focus performance
- x, y range
- thermal stability
- cost, weight, size stage+optics

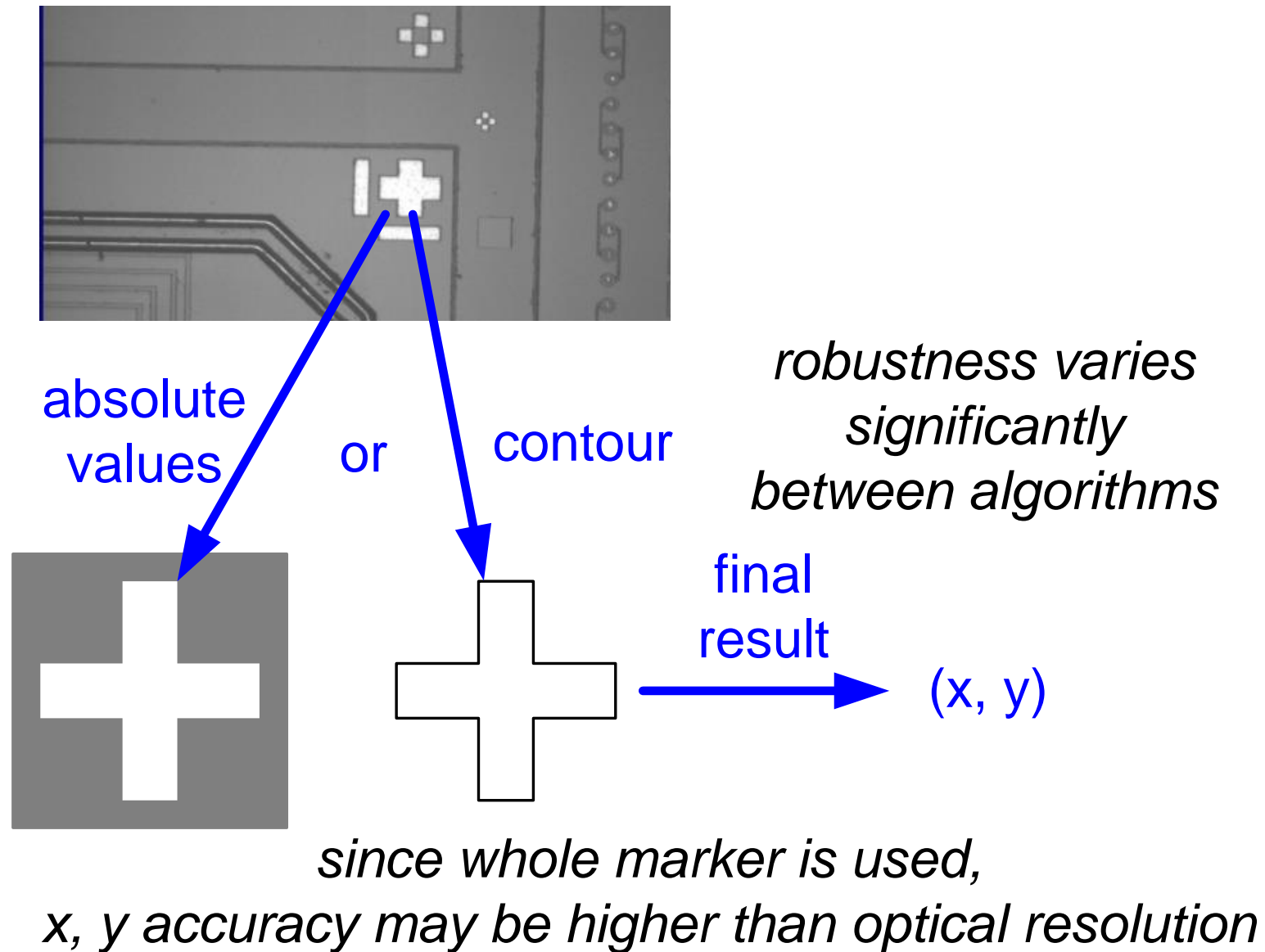
# The Alignment Subsystem



# Alignment Workflow



# Alignment Algorithm





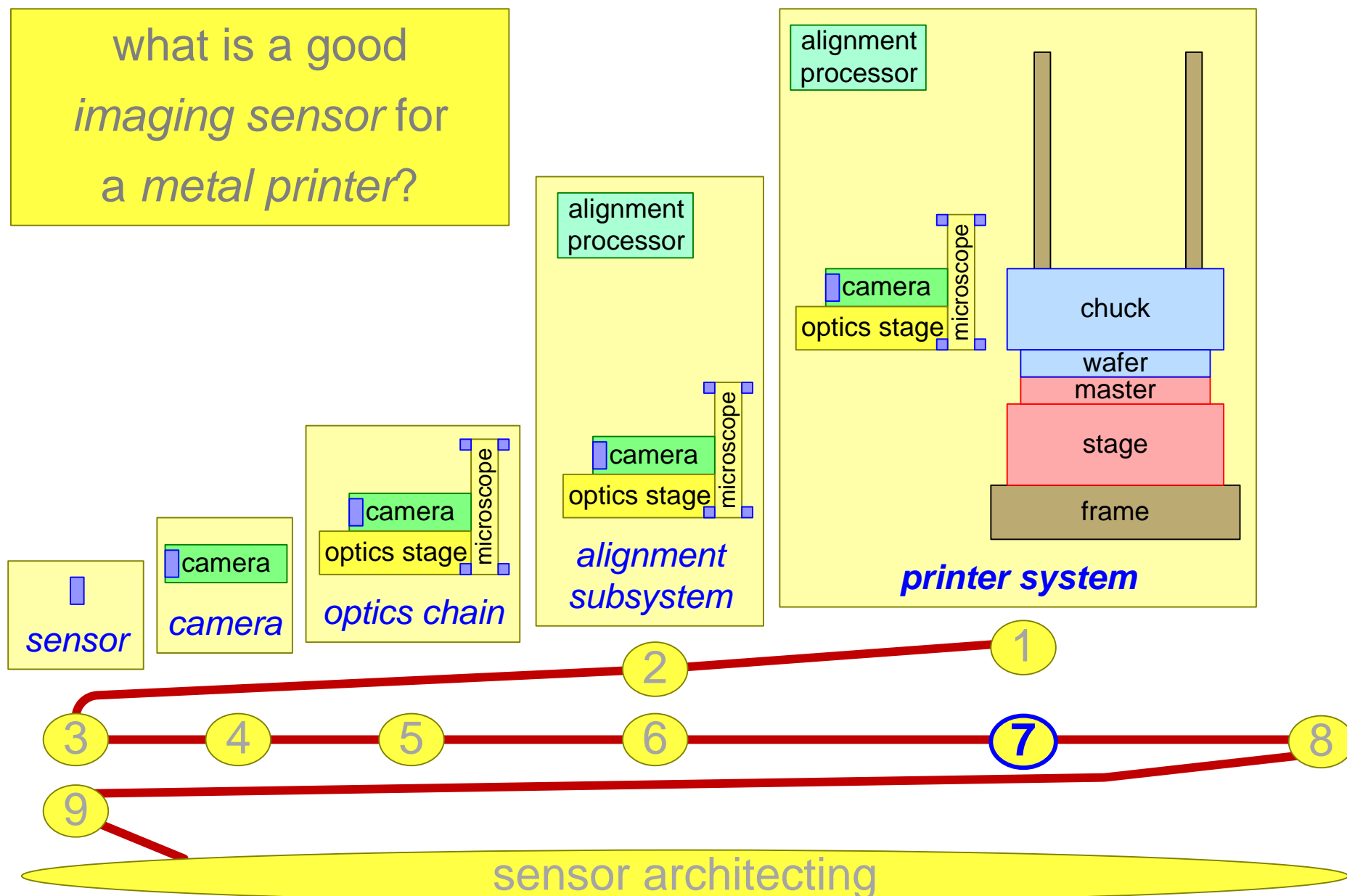
What are the 3 to 5  
*Key Performance Parameters*  
of the alignment subsystem?

What are the 3 to 5  
*Key Performance Parameters*  
of the subsystem incorporating your  
sensor?

Possible  
*Key Performance Parameters*  
of the alignment subsystem

- dx, dy after alignment
- alignment cycle time
- robustness for markers, patterns, wafers, temperature
- cost, weight, size subsystem

# The Printer System



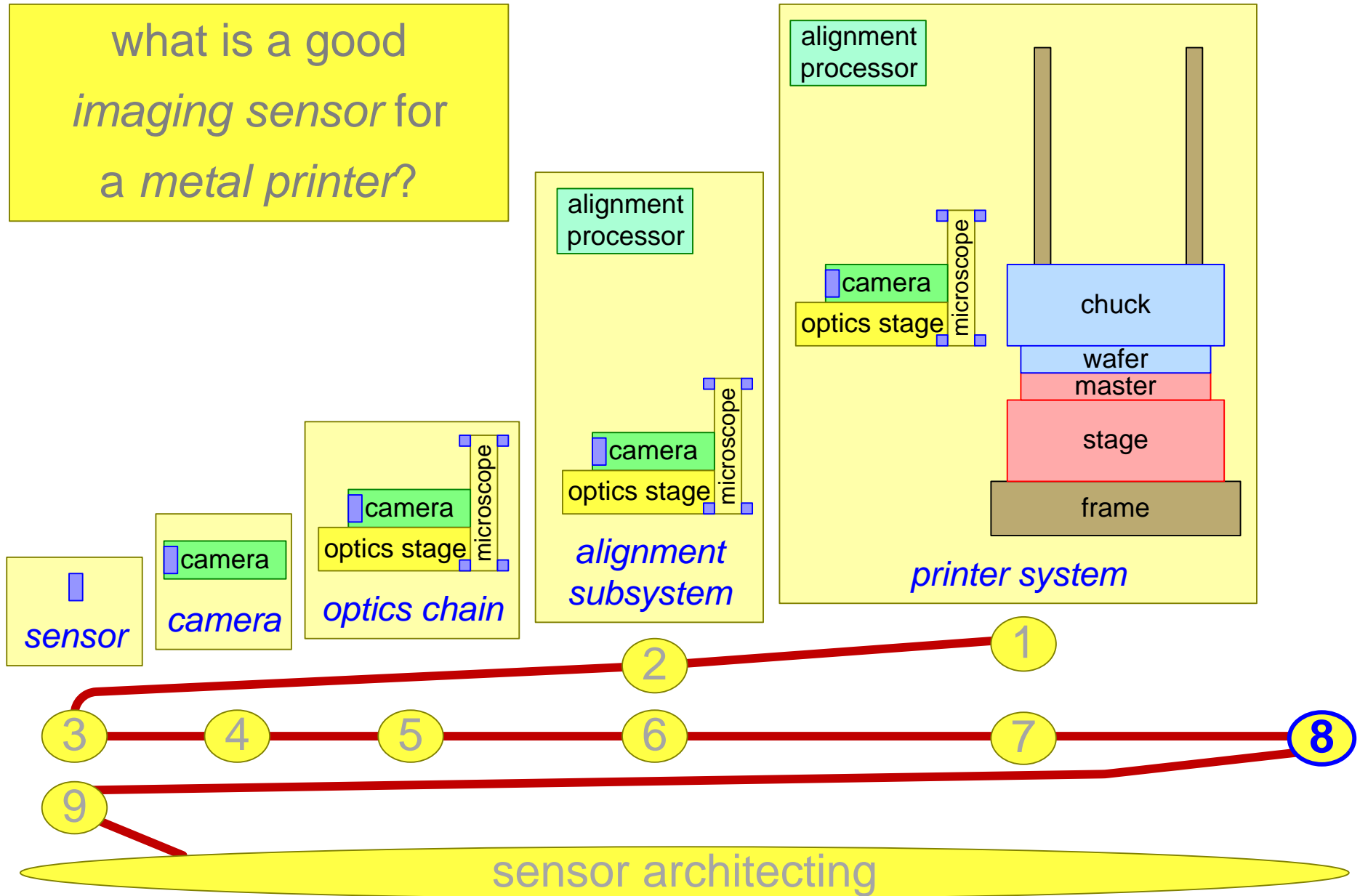
What are the 3 to 5  
*Key Performance Parameters*  
of the printer system?

What are the 3 to 5  
*Key Performance Parameters*  
of the system incorporating your  
sensor?

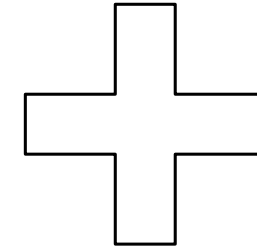
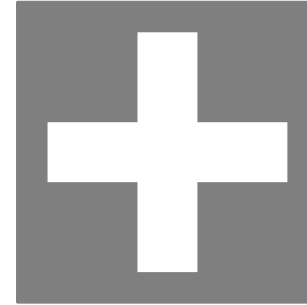
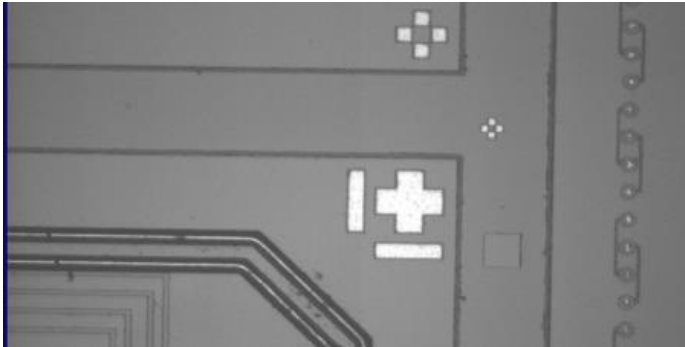
Possible  
*Key Performance Parameters*  
of the printer system

- print quality (pattern resolution, cross section control)
- overlay (=positioning accuracy)
- throughput
- reliability (uptime, high MTBF)
- robustness for markers, patterns, wafers, temperature
- integral costs (system cost, operational costs)
- consumables and waste
- fab interoperability (wafers and information)
- footprint

# The Context



# How Process can Influence Alignment



Context: process influence on alignment

what if little contrast



what if slow transition



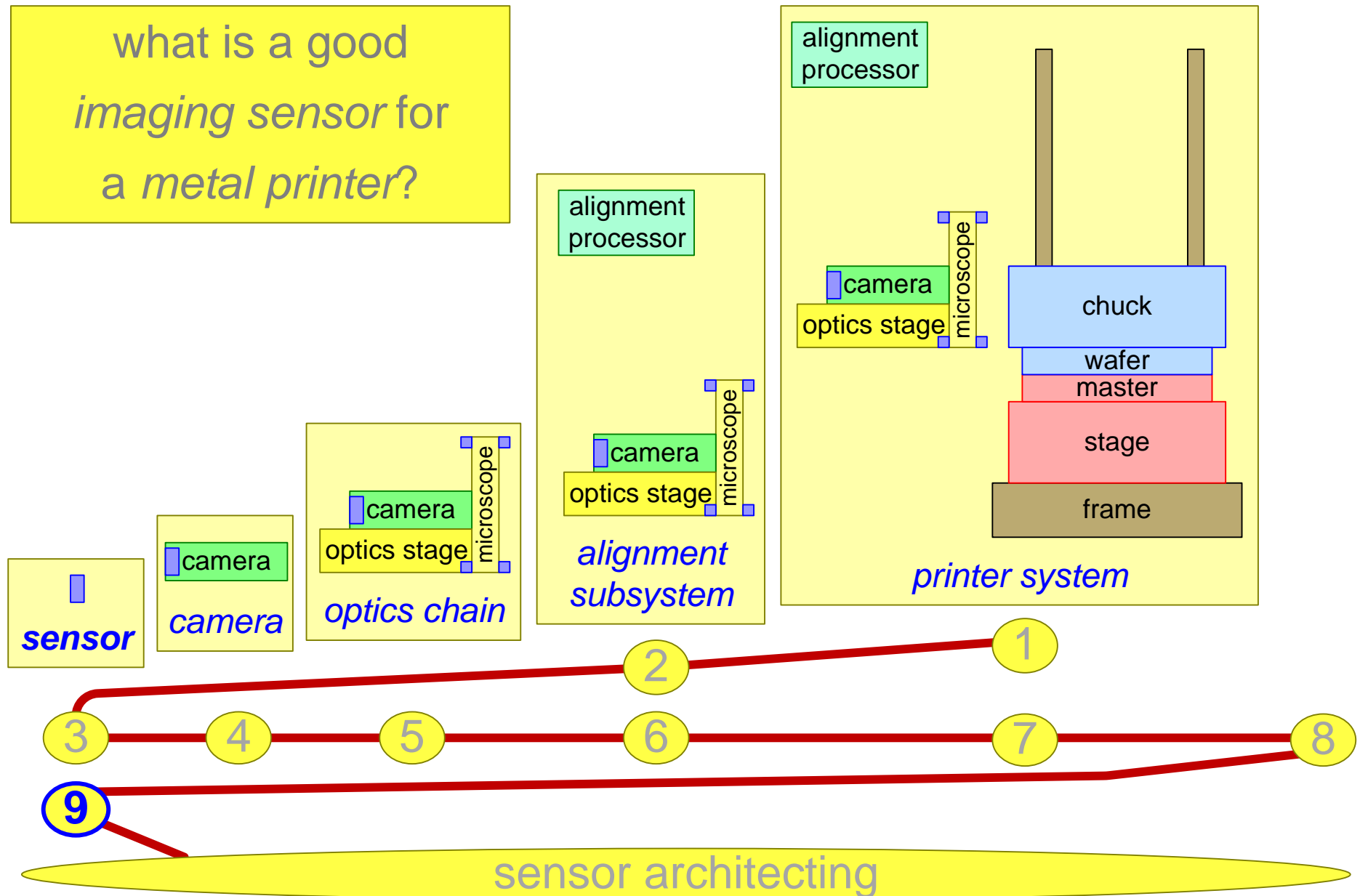
what if wafer surface height varies



what if shadows

what if marker is damaged

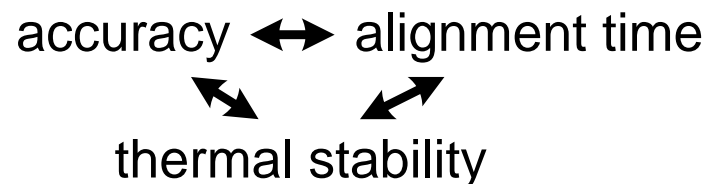
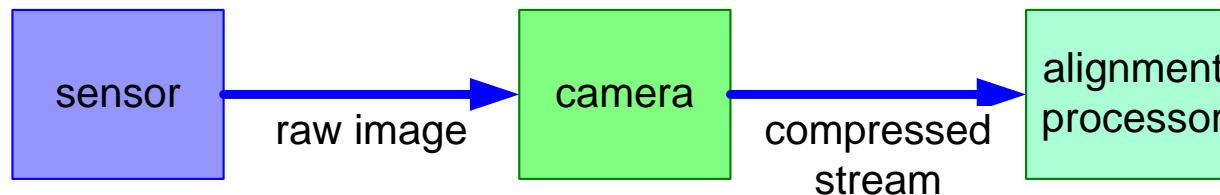
# Revisiting the Sensor



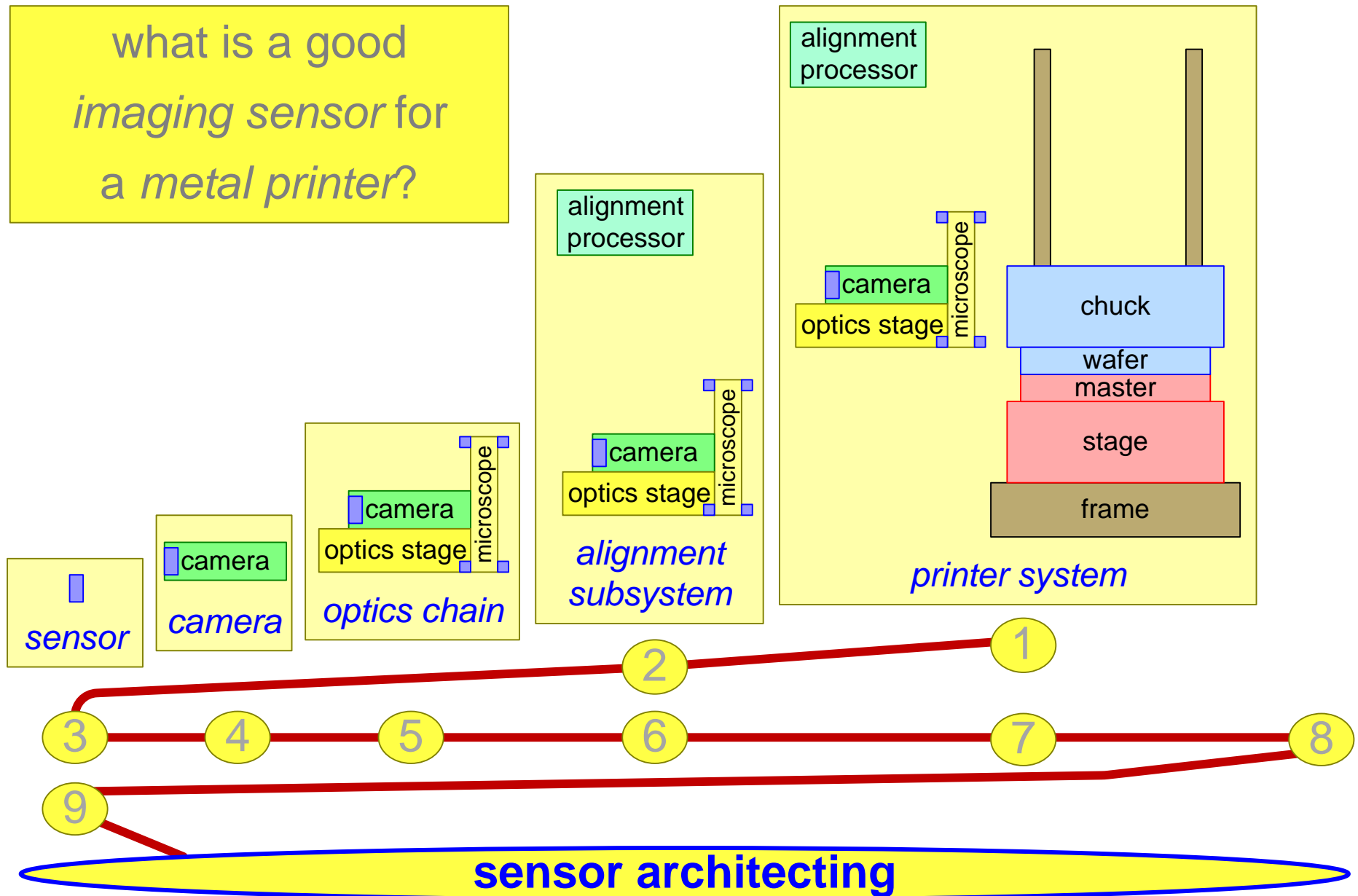


# Part of the Design Space

	<i>benefits</i>	<i>disadvantages</i>
high resolution	accurate dx, dy	long acq time long transfer time long calculation time high energy consumption
large FoV	easy to find markers	long acq time long transfer time high energy consumption
red light	visibility marker	low optical resolution
blue light	high optical resolution	poor visibility marker
continuous on	thermal steady state	requires continuous cooling



# Sensor Architecting



# Sensor Architecting: 8 Orders Zoom in-out

